



P-Channel 12 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)			
	0.037 at V _{GS} = - 4.5 V	- 7.3				
- 12	0.046 at V _{GS} = - 2.5 V	- 6.6	19			
	0.060 at V _{GS} = - 1.8 V	- 5.8				

FEATURES

- TrenchFET® Power MOSFET
- MICRO FOOT® Chipscale Packaging Reduces Footprint Area Profile (0.62 mm) and On-Resistance Per Footprint Area

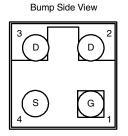


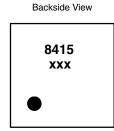
FREE

Ultra-Low On-Resistance

Material categorization: definitions compliance please see www.vishay.com/doc?99912

MICRO FOOT



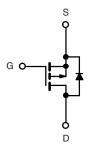


Device Marking: 8415

xxx = Date/Lot Traceability Code

APPLICATIONS

Load Switch, Charger Switch, and PA Switch for Portable Devices



P-Channel MOSFET

Ordering Information: Si8415DB-T1-E1 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)						
Parameter		Symbol	5 s	Steady State	Unit	
Drain-Source Voltage		V_{DS}	- 12		V	
Gate-Source Voltage		V_{GS}	± 8			
Continuous Proin Current /T 150 °C\8	T _A = 25 °C	I _D	- 7.3	- 5.3		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		- 5.9	- 4.3	^	
Pulsed Drain Current		I _{DM}	- 25		Α	
Continuous Source Current (Diode Conduction) ^a		I _S	- 2.5	- 1.3		
M	T _A = 25 °C	P _D	2.77	1.47	W	
Maximum Power Dissipation ^a	T _A = 70 °C		1.77	0.94	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	
Package Reflow Conditions ^b	IR/Convection		260		· C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum landing to Audienta	t ≤ 5 s	R _{thJA}	35	45		
Maximum Junction-to-Ambient ^a	Steady State	' ¹thJA	72	85	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	16	20		

- a. Surface mounted on 1" x 1" FR4 board.
- b. Refer to IPC/JEDEC (J-STD-020), no manual or hand soldering.
- c. In this document, any reference to case represents the body of the MICRO FOOT device and foot is the bump.

Document Number: 73210 S13-1847-Rev. C, 19-Aug-13 For technical questions, contact: pmostechsupport@vishav.com

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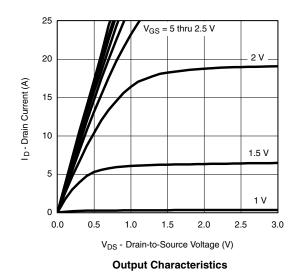
SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Conditions Min.		Max.	Unit	
Static							
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$ - 0.4			- 1	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zara Cata Valtana Duain Comunant	1	V _{DS} = - 12 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 12 V, V _{GS} = 0 V, T _J = 70 °C			- 5	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 5 V, $V_{GS} =$ - 4.5 V	- 5			Α	
		V _{GS} = - 4.5 V, I _D = - 1 A		0.031	0.037		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 1 A		0.038	0.046	Ω	
		V _{GS} = - 1.8 V, I _D = - 1 A 0.050		0.050	0.060		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 1 A		11		S	
Diode Forward Voltage ^a	V_{SD}	I _S = - 1 A, V _{GS} = 0 V		- 0.8	- 1.1	V	
Dynamic ^b							
Total Gate Charge	Q_g			19	30		
Gate-Source Charge	Q_{gs}	$V_{DS} = -6 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -1 \text{ A}$		1.9		nC	
Gate-Drain Charge	Q_{gd}			4.8			
Gate Resistance	R_{g}	f = 1 MHz		19		Ω	
Turn-On Delay Time	t _{d(on)}			15	25		
Rise Time	t _r	V_{DD} = - 6 V, R_L = 6 Ω		32	50		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong\text{-}$ 1 A, $\text{V}_\text{GEN}=\text{-}$ 4.5 V, $\text{R}_\text{g}=\text{6}~\Omega$		180	270	ns	
Fall Time	t _f			115	175		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 1 A, dI/dt = 100 A/μs		80	120		

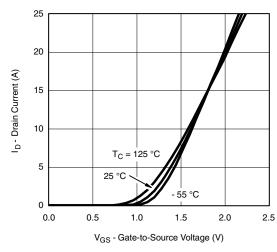
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

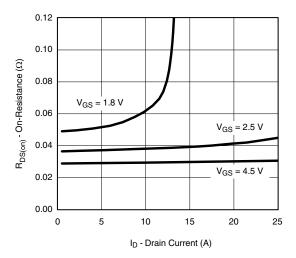




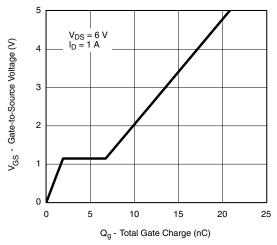
Transfer Characteristics



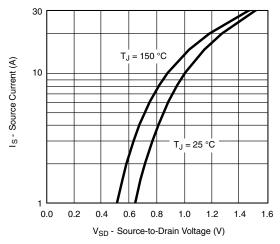
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



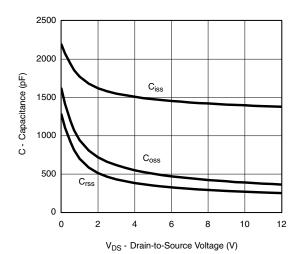
On-Resistance vs. Drain Current



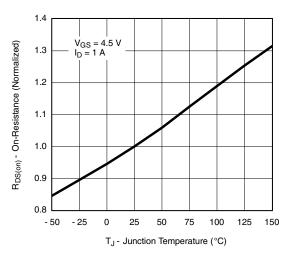
Gate Charge



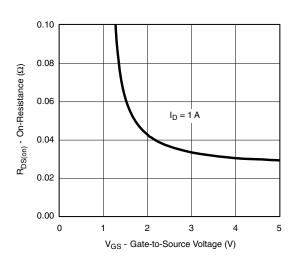
Source-Drain Diode Forward Voltage



Capacitance



On-Resistance vs. Junction Temperature

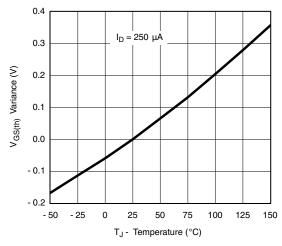


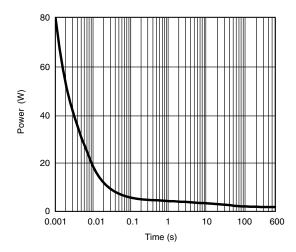
On-Resistance vs. Gate-to-Source Voltage

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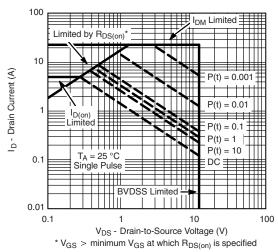
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



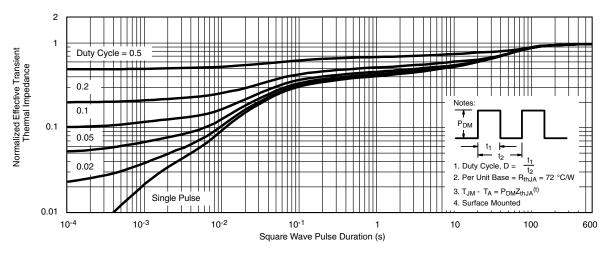


Threshold Voltage

Single Pulse Power, Junction-to-Ambient



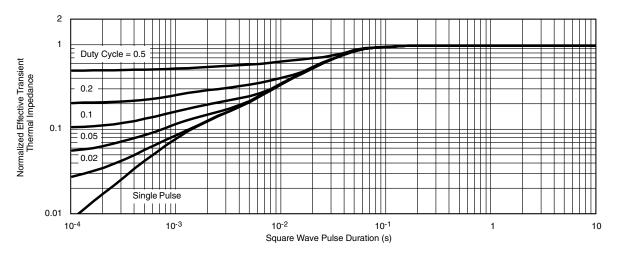




Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



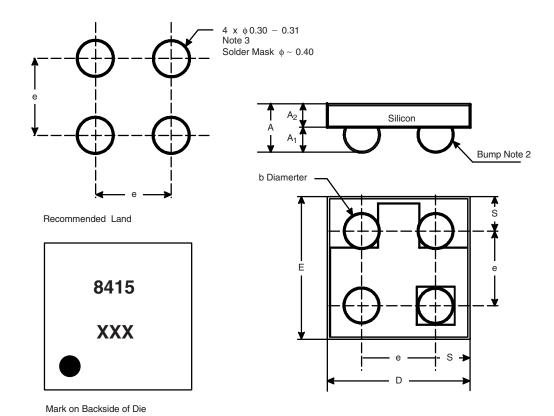
Normalized Thermal Transient Impedance, Junction-to-Foot

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PACKAGE OUTLINE

MICRO FOOT: 4-BUMP (0.8 mm PITCH)





Notes (unless otherwise specified):

- 1. Laser mark on the silicon die back, coated with a thin metal.
- 2. Bumps are 95.5/3.8/0.7 Sn/Ag/Cu.
- 3. Non-solder mask defined copper landing pad.
- 4. The flat side of wafers is oriented at the bottom.

Dim.	Millimeters ^a		Inches		
	Min.	Max.	Min.	Max.	
Α	0.600	0.650	0.0236	0.0256	
A ₁	0.260	0.290	0.0102	0.0114	
A ₂	0.340	0.360	0.0134	0.0142	
b	0.370	0.410	0.0146	0.0161	
D	1.520	1.600	0.0598	0.0630	
E	1.520	1.600	0.0598	0.0630	
е	0.800		0.03	315	
S	0.360	0.400	0.0142	0.0157	

Notes:

a. Use millimeters as the primary measurement.

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